Vorläufig  
preliminary**Elektrische Eigenschaften / electrical properties****Höchstzulässige Werte / maximum rated values****Diode Gleichrichter/ diode rectifier**

Periodische Rückw. Spitzensperrspannung repetitive peak reverse voltage	$T_{vj} = 25^\circ C$	$V_{RRM}$	800	V
Durchlaßstrom Grenzeffektivwert pro Chip RMS forward current per chip	$T_C = 80^\circ C$	$I_{FRMSM}$	58	A
Gleichrichter Ausgang Grenzeffektivstrom maximum RMS current at Rectifier output	$T_C = 80^\circ C$	$I_{RMSmax}$	50	A
Stoßstrom Grenzwert surge forward current	$t_p = 10 \text{ ms}, T_{vj} = 25^\circ C$ $t_p = 10 \text{ ms}, T_{vj} = 150^\circ C$	$I_{FSM}$	448 358	A A
Grenzlastintegral $I^2t$ - value	$t_p = 10 \text{ ms}, T_{vj} = 25^\circ C$ $t_p = 10 \text{ ms}, T_{vj} = 150^\circ C$	$I^2t$	1000 642	$A^2s$ $A^2s$

**Transistor Wechselrichter/ transistor inverter**

Kollektor-Emitter-Sperrspannung collector-emitter voltage	$T_{vj} = 25^\circ C$	$V_{CES}$	600	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 65^\circ C$ $T_C = 25^\circ C$	$I_{C,nom.}$ $I_C$	15 19	A A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_p = 1 \text{ ms}, T_C = 65^\circ C$	$I_{CRM}$	30	A
Gesamt-Verlustleistung total power dissipation	$T_C = 25^\circ C$	$P_{tot}$	60	W
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		$V_{GES}$	+/- 20V	V

**Diode Wechselrichter/ diode inverter**

Dauergleichstrom DC forward current		$I_F$	15	A
Periodischer Spitzenstrom repetitive peak forw. current	$t_p = 1 \text{ ms}$	$I_{FRM}$	30	A
Grenzlastintegral $I^2t$ - value	$V_R = 0V, t_p = 10ms, T_{vj} = 125^\circ C$	$I^2t$	25	$A^2s$

**Transistor Brems-Chopper/ transistor brake-chopper**

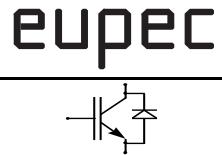
Kollektor-Emitter-Sperrspannung collector-emitter voltage	$T_{vj} = 25^\circ C$	$V_{CES}$	600	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 65^\circ C$ $T_C = 25^\circ C$	$I_{C,nom.}$ $I_C$	15 19	A A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_p = 1 \text{ ms}, T_C = 65^\circ C$	$I_{CRM}$	30	A
Gesamt-Verlustleistung total power dissipation	$T_C = 25^\circ C$	$P_{tot}$	60	W
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		$V_{GES}$	+/- 20V	V

**Diode Brems-Chopper/ diode brake-chopper**

Dauergleichstrom DC forward current		$I_F$	15	A
Periodischer Spitzenstrom repetitive peak forw. current	$t_p = 1 \text{ ms}$	$I_{FRM}$	30	A

prepared by: Thomas Passe	date of publication: 2003-03-26
approved by: R. Keggenhoff	revision: 2.1

Technische Information / technical information  
IGBT-Module  
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Vorläufig  
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**Modul Isolation/ module isolation**

Isolations-Prüfspannung insulation test voltage	RMS, f = 50 Hz, t = 1 min. NTC connected to Baseplate	V <sub>ISOL</sub>	2,5	kV
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**Elektrische Eigenschaften / electrical properties**

**Charakteristische Werte / characteristic values**

**Diode Gleichrichter/ diode rectifier**

			min.	typ.	max.
Durchlaßspannung forward voltage	T <sub>vj</sub> = 150°C, I <sub>F</sub> = 15 A	V <sub>F</sub>	-	0,8	-
Schleusenspannung threshold voltage	T <sub>vj</sub> = 150°C	V <sub>(TO)</sub>	-	0,61	-
Ersatzwiderstand slope resistance	T <sub>vj</sub> = 150°C	r <sub>T</sub>	-	11	-
Sperrstrom reverse current	T <sub>vj</sub> = 150°C, V <sub>R</sub> = 800 V	I <sub>R</sub>	-	5	-
Modul Leitungswiderstand, Anschlüsse-Chip lead resistance, terminals-chip	T <sub>C</sub> = 25°C	R <sub>AA+CC'</sub>	-	11	-

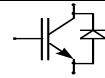
**Transistor Wechselrichter/ transistor inverter**

			min.	typ.	max.
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	V <sub>GE</sub> = 15V, T <sub>vj</sub> = 25°C, I <sub>C</sub> = 15 A V <sub>GE</sub> = 15V, T <sub>vj</sub> = 125°C, I <sub>C</sub> = 15 A	V <sub>CE sat</sub>	-	1,95	2,55
Gate-Schwellenspannung gate threshold voltage	V <sub>CE</sub> = V <sub>GE</sub> , T <sub>vj</sub> = 25°C, I <sub>C</sub> = 0,4mA	V <sub>GE(TO)</sub>	4,5	5,5	6,5
Eingangskapazität input capacitance	f = 1MHz, T <sub>vj</sub> = 25°C V <sub>CE</sub> = 25 V, V <sub>GE</sub> = 0 V	C <sub>ies</sub>	-	0,8	-
Kollektor-Emitter Reststrom collector-emitter cut-off current	V <sub>GE</sub> = 0V, T <sub>vj</sub> = 25°C, V <sub>CE</sub> = 600V	I <sub>CES</sub>	-	-	5,0
Gate-Emitter Reststrom gate-emitter leakage current	V <sub>CE</sub> = 0V, V <sub>GE</sub> = 20V, T <sub>vj</sub> = 25°C	I <sub>GES</sub>	-	-	400
Einschaltverzögerungszeit (ind. Last) turn on delay time (inductive load)	I <sub>C</sub> = I <sub>Nenn</sub> V <sub>CC</sub> = 300 V V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 25°C, R <sub>G</sub> = 68 Ohm V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 125°C, R <sub>G</sub> = 68 Ohm	t <sub>d, on</sub>	-	37	-
Anstiegszeit (induktive Last) rise time (inductive load)	I <sub>C</sub> = I <sub>Nenn</sub> V <sub>CC</sub> = 300 V V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 25°C, R <sub>G</sub> = 68 Ohm V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 125°C, R <sub>G</sub> = 68 Ohm	t <sub>r</sub>	-	37	-
Abschaltverzögerungszeit (ind. Last) turn off delay time (inductive load)	I <sub>C</sub> = I <sub>Nenn</sub> V <sub>CC</sub> = 300 V V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 25°C, R <sub>G</sub> = 68 Ohm V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 125°C, R <sub>G</sub> = 68 Ohm	t <sub>d, off</sub>	-	216	-
Fallzeit (induktive Last) fall time (inductive load)	I <sub>C</sub> = I <sub>Nenn</sub> V <sub>CC</sub> = 300 V V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 25°C, R <sub>G</sub> = 68 Ohm V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 125°C, R <sub>G</sub> = 68 Ohm	t <sub>f</sub>	-	17	-
Einschaltverlustenergie pro Puls turn-on energy loss per pulse	I <sub>C</sub> = I <sub>Nenn</sub> V <sub>CC</sub> = 300 V V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 125°C, R <sub>G</sub> = 68 Ohm L <sub>S</sub> = 80 nH	E <sub>on</sub>	-	0,6	-
Abschaltverlustenergie pro Puls turn-off energy loss per pulse	I <sub>C</sub> = I <sub>Nenn</sub> V <sub>CC</sub> = 300 V V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 125°C, R <sub>G</sub> = 68 Ohm L <sub>S</sub> = 80 nH	E <sub>off</sub>	-	0,4	-
Kurzschlußverhalten SC Data	t <sub>P</sub> ≤ 10µs, V <sub>GE</sub> ≤ 15V, R <sub>G</sub> = 68 Ohm T <sub>vj</sub> ≤ 125°C, V <sub>CC</sub> = 360 V dI/dt = 1000 A/µs	I <sub>sc</sub>	-	60	-

# Technische Information / technical information

IGBT-Module  
IGBT-Modules

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**Vorläufig**  
**preliminary**

## Elektrische Eigenschaften / electrical properties

### Charakteristische Werte / characteristic values

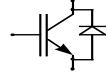
			L <sub>σCE</sub>	-	-	40	nH
Modulinduktivität stray inductance module							
Modul Leitungswiderstand, Anschlüsse-Chip lead resistance, terminals-chip	T <sub>C</sub> = 25°C		R <sub>CC+EE'</sub>	-	10	-	mΩ
Diode Wechselrichter/ diode inverter				min.	typ.	max.	
Durchlaßspannung forward voltage	V <sub>GE</sub> = 0V, T <sub>vj</sub> = 25°C, I <sub>F</sub> = 15 A V <sub>GE</sub> = 0V, T <sub>vj</sub> = 125°C, I <sub>F</sub> = 15 A		V <sub>F</sub>	-	1,75	2,15	V
Rückstromspitze peak reverse recovery current	I <sub>F</sub> =I <sub>Nenn</sub> , - di <sub>F</sub> /dt = 600 A/us V <sub>GE</sub> = -10V, T <sub>vj</sub> = 25°C, V <sub>R</sub> = 300 V V <sub>GE</sub> = -10V, T <sub>vj</sub> = 125°C, V <sub>R</sub> = 300 V		I <sub>RM</sub>	-	13	-	A
Sperrverzögerungsladung recovered charge	I <sub>F</sub> =I <sub>Nenn</sub> , - di <sub>F</sub> /dt = 600 A/us V <sub>GE</sub> = -10V, T <sub>vj</sub> = 25°C, V <sub>R</sub> = 300 V V <sub>GE</sub> = -10V, T <sub>vj</sub> = 125°C, V <sub>R</sub> = 300 V		Q <sub>r</sub>	-	0,8	-	μAs
Abschaltenergie pro Puls reverse recovery energy	I <sub>F</sub> =I <sub>Nenn</sub> , - di <sub>F</sub> /dt = 600 A/us V <sub>GE</sub> = -10V, T <sub>vj</sub> = 25°C, V <sub>R</sub> = 300 V V <sub>GE</sub> = -10V, T <sub>vj</sub> = 125°C, V <sub>R</sub> = 300 V		E <sub>rec</sub>	-	0,14	-	mJ
				-	0,24	-	mJ
Transistor Brems-Chopper/ transistor brake-chopper				min.	typ.	max.	
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	V <sub>GE</sub> = 15V, T <sub>vj</sub> = 25°C, I <sub>C</sub> = 15,0 A V <sub>GE</sub> = 15V, T <sub>vj</sub> = 125°C, I <sub>C</sub> = 15,0 A		V <sub>CE sat</sub>	-	1,95	2,55	V
Gate-Schwellenspannung gate threshold voltage	V <sub>CE</sub> = V <sub>GE</sub> , T <sub>vj</sub> = 25°C, I <sub>C</sub> = 0,4mA		V <sub>GE(TO)</sub>	4,5	5,5	6,5	V
Eingangskapazität input capacitance	f = 1MHz, T <sub>vj</sub> = 25°C V <sub>CE</sub> = 25 V, V <sub>GE</sub> = 0 V		C <sub>ies</sub>	-	0,8	-	nF
Kollektor-Emitter Reststrom collector-emitter cut-off current	V <sub>GE</sub> = 0V, T <sub>vj</sub> = 25°C, V <sub>CE</sub> = 600V			-	-	5,0	mA
Gate-Emitter Reststrom gate-emitter leakage current	V <sub>CE</sub> = 0V, V <sub>GE</sub> = 20V, T <sub>vj</sub> = 25°C		I <sub>GES</sub>	-	-	400	nA
Diode Brems-Chopper/ diode brake-chopper				min.	typ.	max.	
Durchlaßspannung forward voltage	T <sub>vj</sub> = 25°C, I <sub>F</sub> = 15A T <sub>vj</sub> = 125°C, I <sub>F</sub> = 15A		V <sub>F</sub>	-	2,15	2,6	V
				-	2,25	-	V
NTC-Widerstand/ NTC-thermistor				min.	typ.	max.	
Nennwiderstand rated resistance	T <sub>C</sub> = 25°C		R <sub>25</sub>	-	5	-	kΩ
Abweichung von R <sub>100</sub> deviation of R <sub>100</sub>	T <sub>C</sub> = 100°C, R <sub>100</sub> = 493 Ω		ΔR/R	-5		5	%
Verlustleistung power dissipation	T <sub>C</sub> = 25°C		P <sub>25</sub>			20	mW
B-Wert B-value	R <sub>2</sub> = R <sub>1</sub> exp [B(1/T <sub>2</sub> - 1/T <sub>1</sub> )]		B <sub>25/50</sub>		3375		K

# Technische Information / technical information

IGBT-Module  
IGBT-Modules

# FB15R06KL4B1

**eupc**



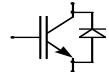
**Vorläufig  
preliminary**

## Thermische Eigenschaften / thermal properties

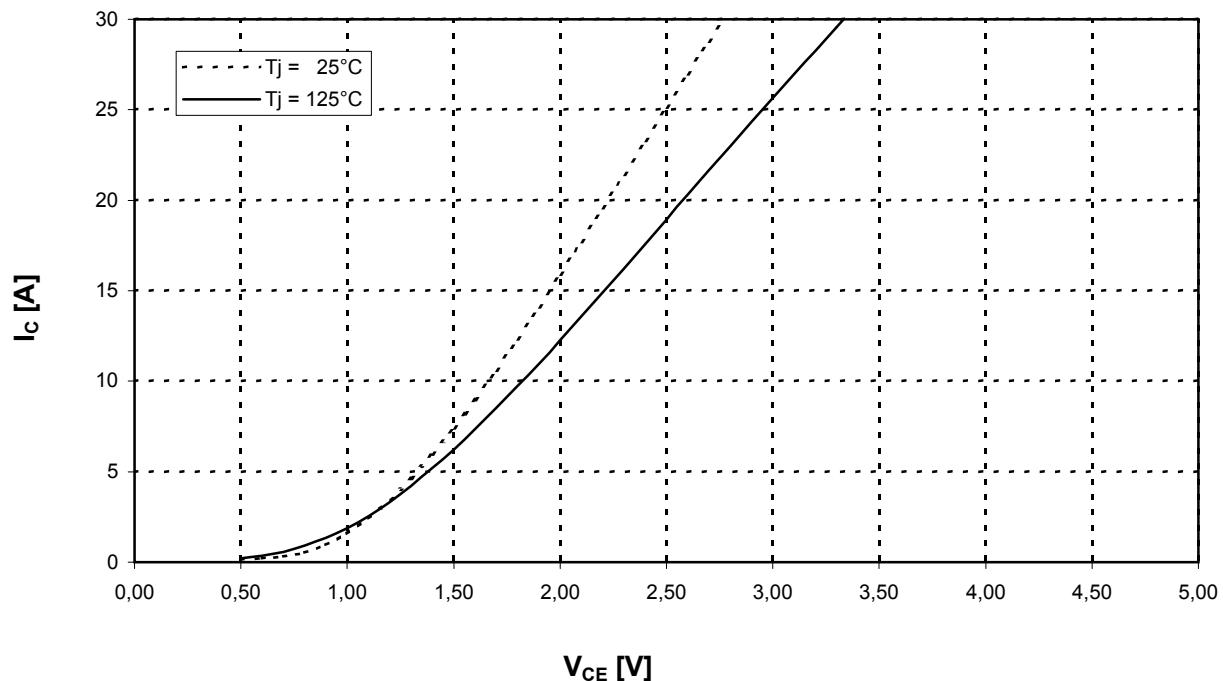
					min.	typ.	max.
Innerer Wärmewiderstand thermal resistance, junction to heatsink	Gleichr. Diode/ rectif. diode	$\lambda_{\text{Paste}}=1\text{W/m}^{\circ}\text{K}$	$R_{\text{thJH}}$	-	1,1	-	K/W
	Trans. Wechselr./ trans. inverter	$\lambda_{\text{grease}}=1\text{W/m}^{\circ}\text{K}$		-	2,4	-	K/W
	Diode Wechselr./ diode inverter			-	4,0	-	K/W
	Trans. Bremse/ trans. brake			-	2,4	-	K/W
	Diode Bremse/ diode brake			-	4,3	-	K/W
Innerer Wärmewiderstand thermal resistance, junction to case	Gleichr. Diode/ rectif. diode		$R_{\text{thJC}}$	-	-	1	K/W
	Trans. Wechselr./ trans. inverter			-	-	2	K/W
	Diode Wechselr./ diode inverter			-	-	2,9	K/W
	Trans. Bremse/ trans. brake			-	-	2	K/W
	Diode Bremse/ diode brake			-	-	3,1	K/W
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	Gleichr. Diode/ rectif. diode	$\lambda_{\text{Paste}}=1\text{W/m}^{\circ}\text{K}$	$R_{\text{thCH}}$	-	0,2	-	K/W
	Trans. Wechselr./ trans. inverter	$\lambda_{\text{grease}}=1\text{W/m}^{\circ}\text{K}$		-	0,6	-	K/W
	Diode Wechselr./ diode inverter			-	1,4	-	K/W
	Trans. Bremse/ trans. brake			-	0,6	-	K/W
	Diode Bremse/ diode brake			-	1,5	-	K/W
Höchstzulässige Sperrsichttemperatur maximum junction temperature			$T_{\text{vj}}$	-	-	150	°C
Betriebstemperatur operation temperature			$T_{\text{op}}$	-40	-	125	°C
Lagertemperatur storage temperature			$T_{\text{stg}}$	-40	-	125	°C

## Mechanische Eigenschaften / mechanical properties

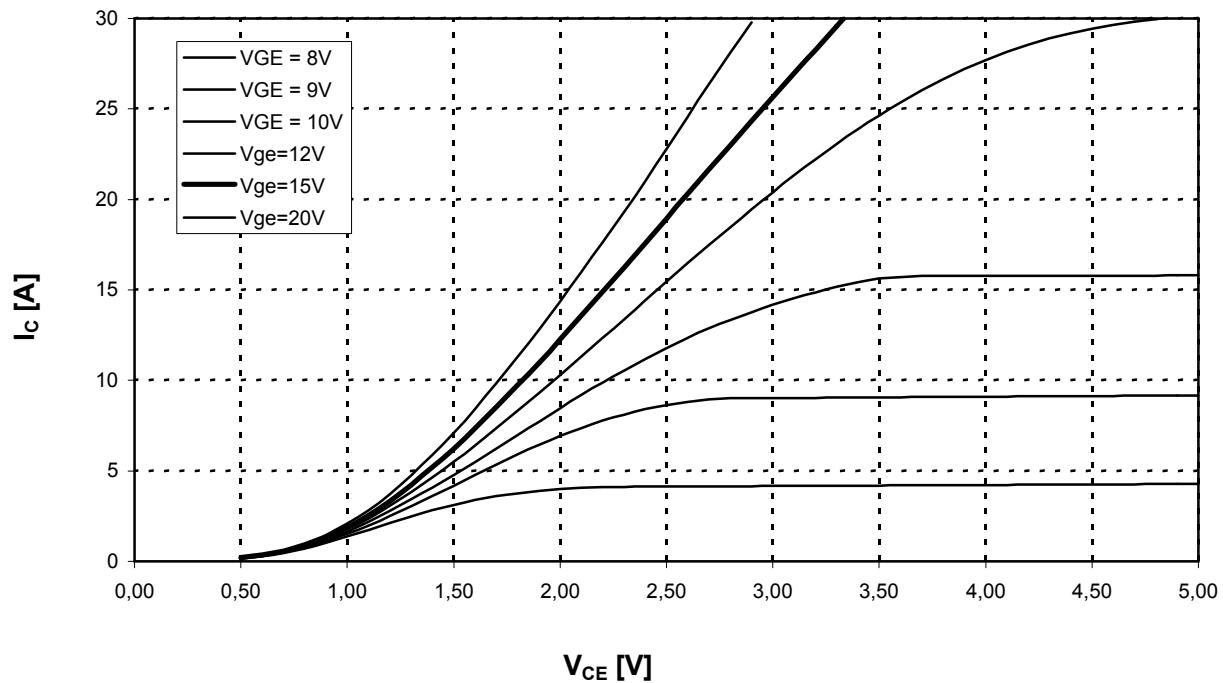
Innere Isolation internal insulation			$\text{Al}_2\text{O}_3$	
CTI comperative tracking index			225	
Anpreßkraft f. mech. Befestigung pro Feder mounting force per clamp		F	40...80	N
Gewicht weight		G	36	g
Kontakt - Kühlkörper terminal to heatsink	Kriechstrecke creepage distance		13,5	mm
	Luftstrecke clearance distance		12	mm
Terminal - Terminal terminal to terminal	Kriechstrecke creepage distance		7,5	mm
	Luftstrecke clearance distance		7,5	mm

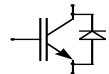
Vorläufig  
preliminary

**Ausgangskennlinienfeld Wechselr. (typisch)**  $I_C = f(V_{CE})$   
**output characteristic inverter (typical)**  $V_{GE} = 15\text{ V}$



**Ausgangskennlinienfeld Wechselr. (typisch)**  $I_C = f(V_{CE})$   
**output characteristic inverter (typical)**  $T_{vj} = 125^\circ\text{C}$



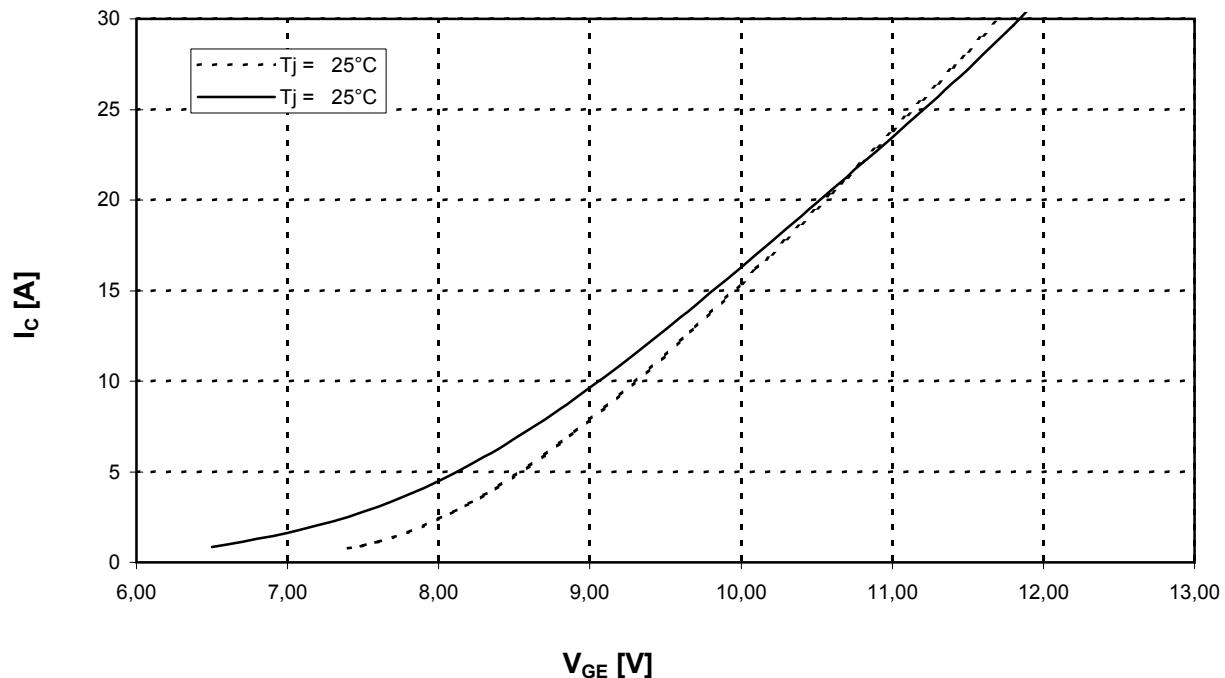
Vorläufig  
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## Übertragungscharakteristik Wechselr. (typisch)

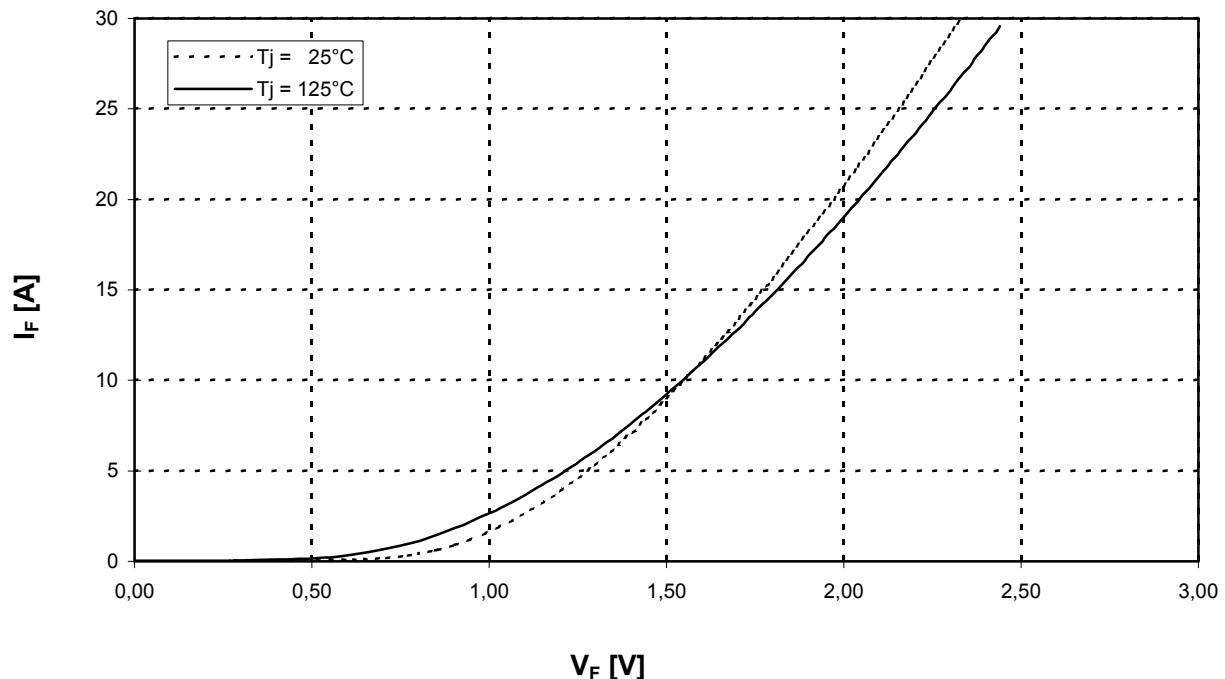
transfer characteristic inverter (typical)

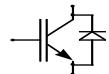
$I_C = f(V_{GE})$

$V_{CE} = 20 \text{ V}$

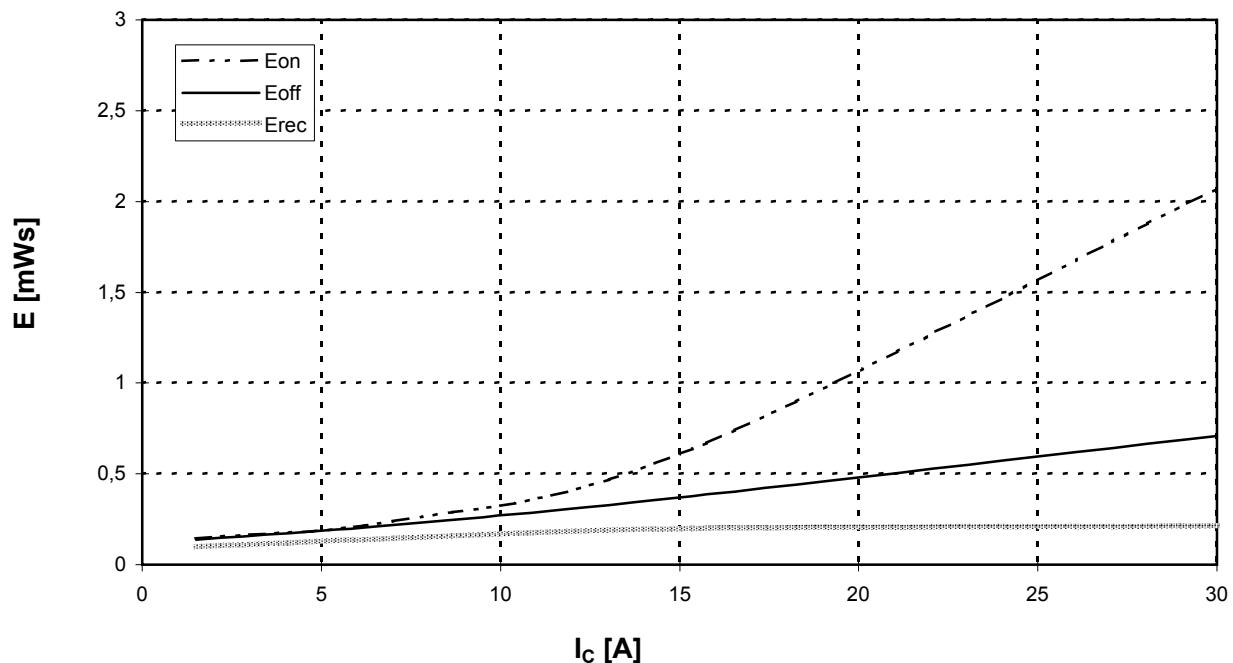
Durchlaßkennlinie der Freilaufdiode Wechselr. (typisch)  $I_F = f(V_F)$ 

forward characteristic of FWD inverter (typical)

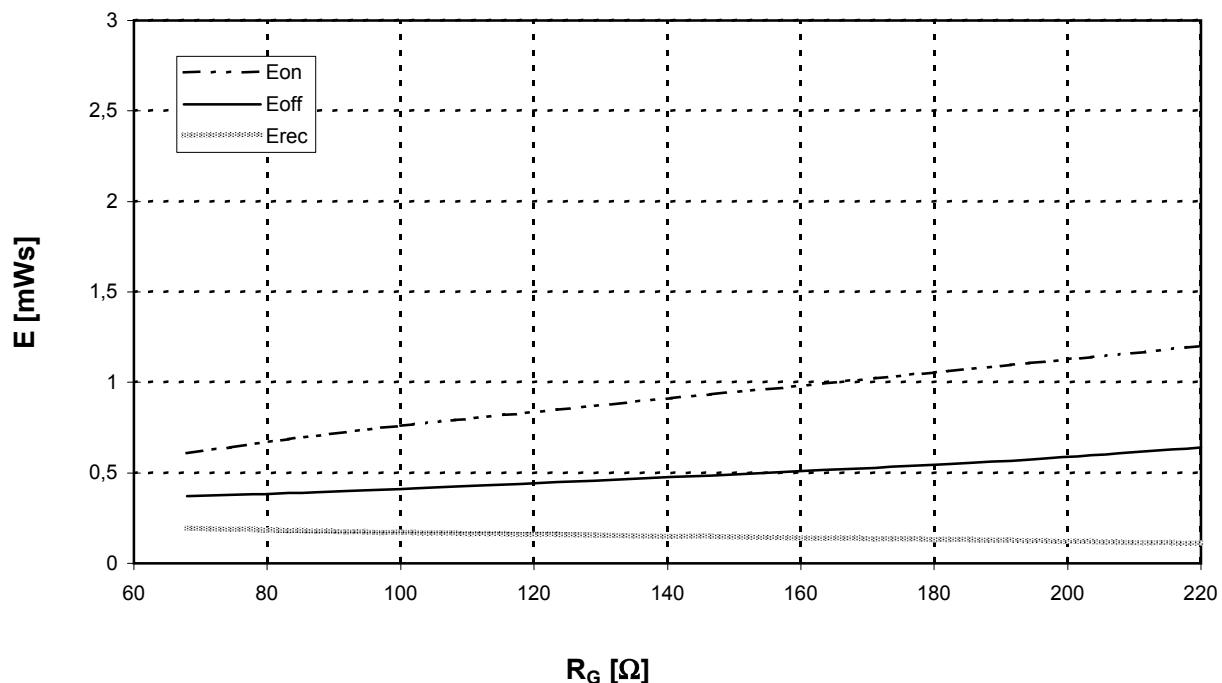


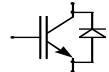
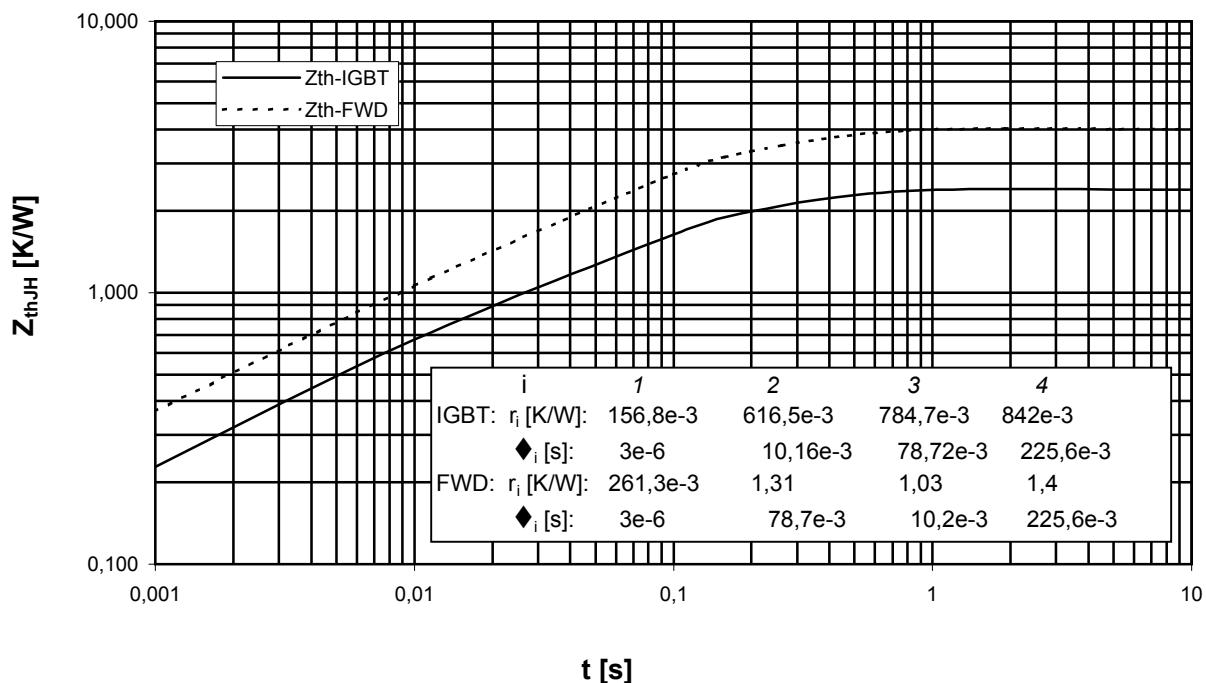
Vorläufig  
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Schaltverluste Wechselr. (typisch)     $E_{on} = f(I_c)$ ,  $E_{off} = f(I_c)$ ,  $E_{rec} = f(I_c)$      $V_{cc} = 300\text{ V}$   
 switching losses inverter (typical)     $T_j = 125^\circ\text{C}$ ,     $V_{GE} = \pm 15\text{ V}$ ,     $R_{Gon} = R_{Goff} = 68\text{ Ohm}$



Schaltverluste Wechselr. (typisch)     $E_{on} = f(R_G)$ ,  $E_{off} = f(R_G)$ ,  $E_{rec} = f(R_G)$   
 switching losses inverter (typical)     $T_j = 125^\circ\text{C}$ ,     $V_{GE} = + - 15\text{ V}$ ,     $I_c = I_{henn}$ ,     $V_{cc} = 300\text{ V}$



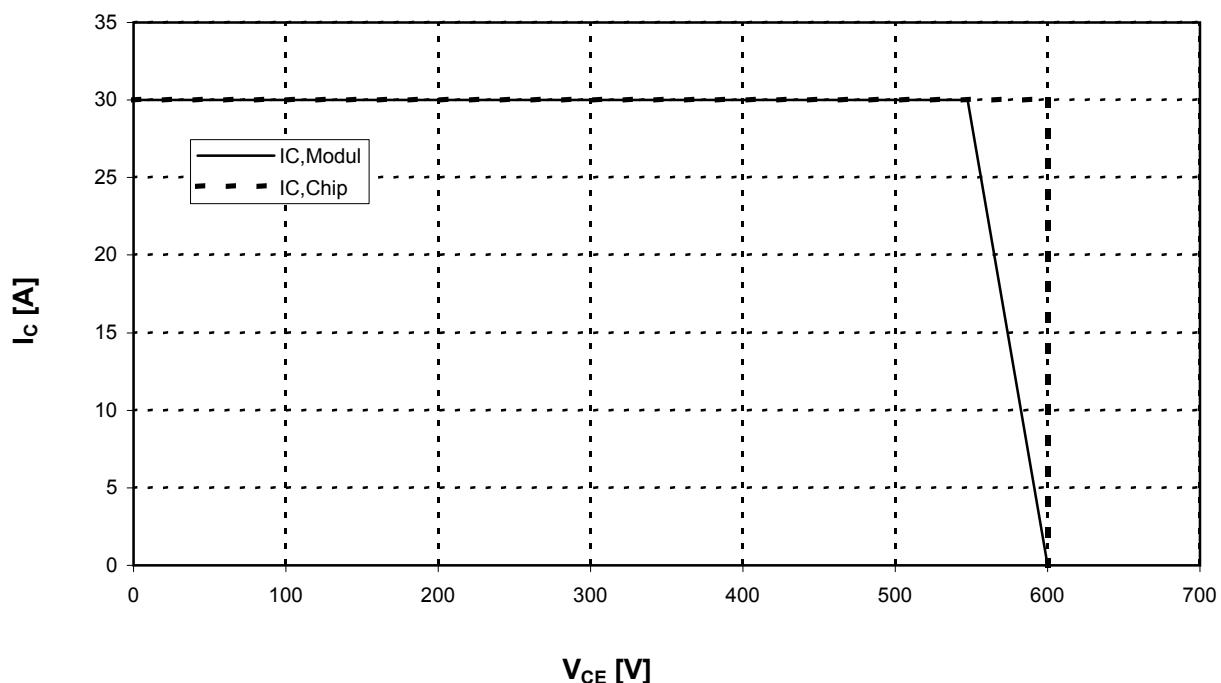
Vorläufig  
preliminaryTransienter Wärmewiderstand Wechselr.  
transient thermal impedance inverter

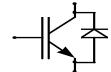
Sicherer Arbeitsbereich Wechselr. (RBSOA)

$I_C = f(V_{CE})$

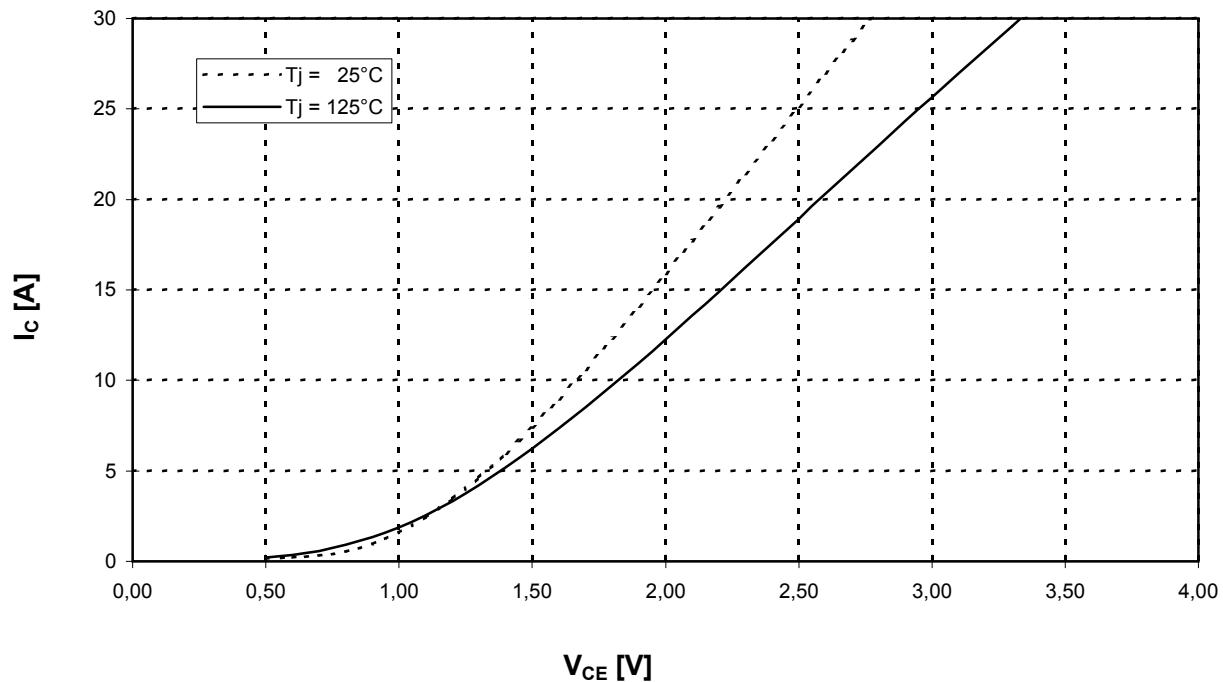
reverse bias save operating area inverter (RBSOA)  $T_{vj} = 125^\circ\text{C}$ ,  $V_{GE} = \pm 15\text{V}$ ,  $R_G =$ 

68 Ohm

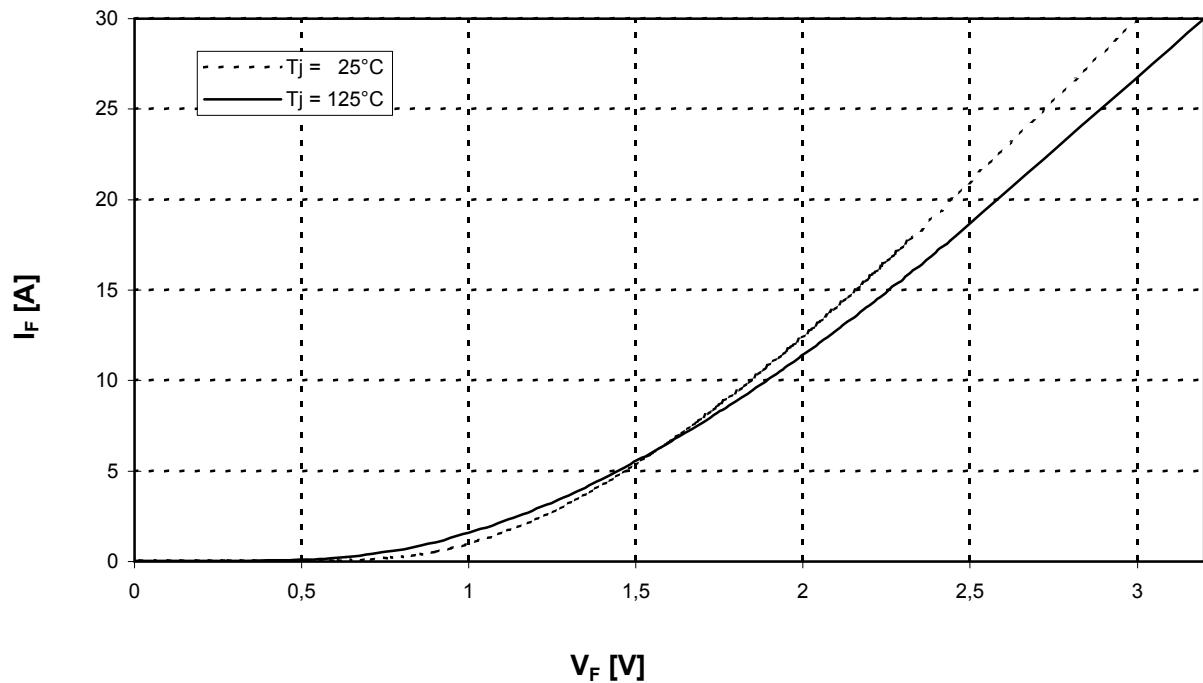


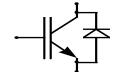
Vorläufig  
preliminary

**Ausgangskennlinienfeld Brems-Chopper-IGBT (typisch)**  $I_C = f(V_{CE})$   
**output characteristic brake-chopper-IGBT (typical)**  $V_{GE} = 15 \text{ V}$

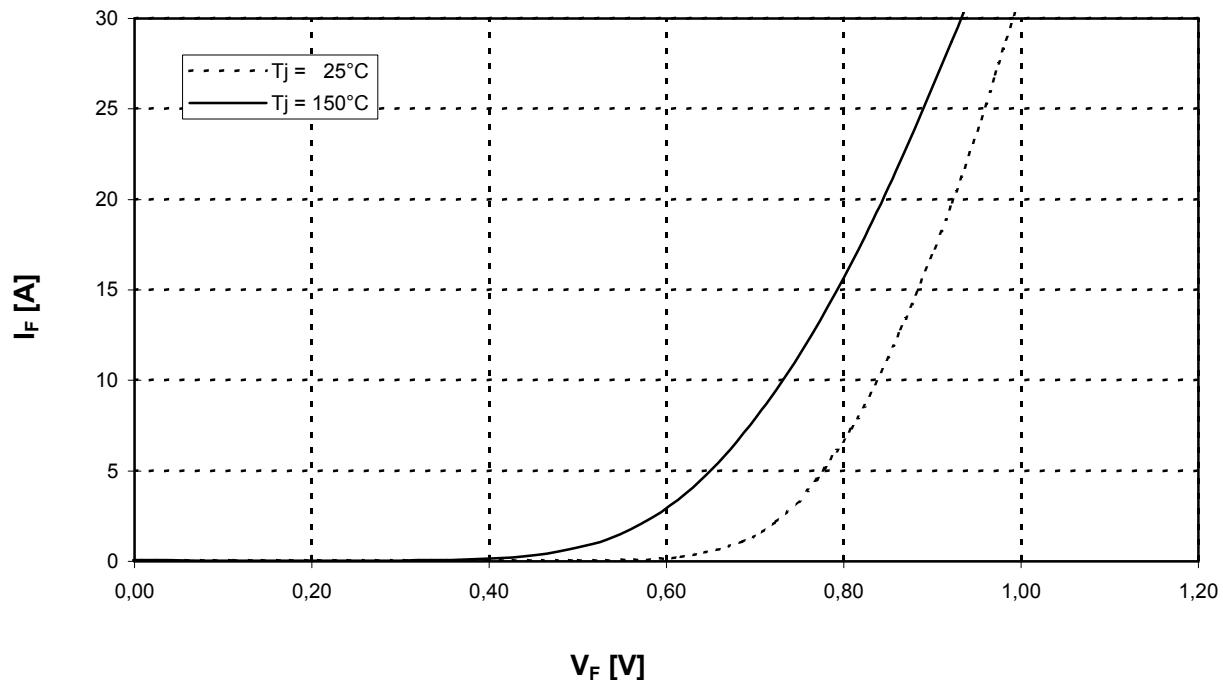


**Durchlaßkennlinie der Brems-Chopper-Diode (typisch)**  $I_F = f(V_F)$   
**forward characteristic of brake-chopper-FWD (typical)**

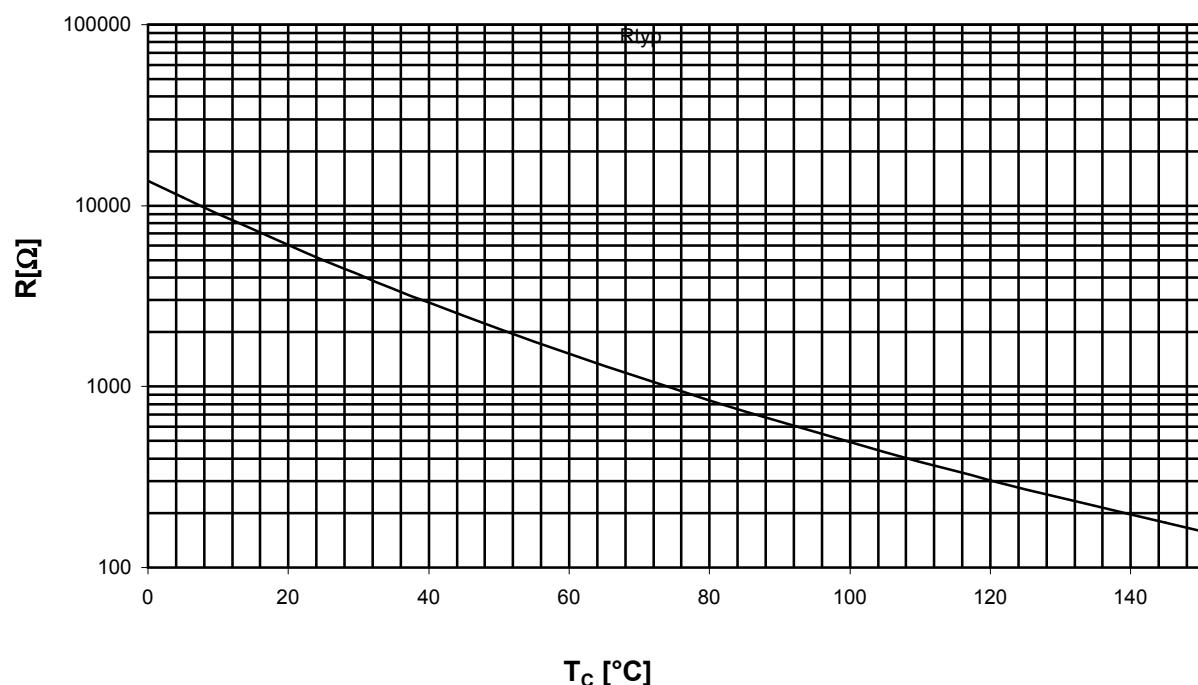


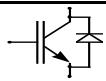
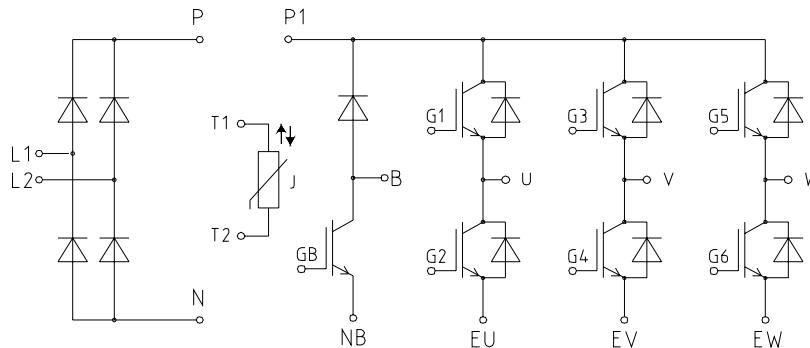
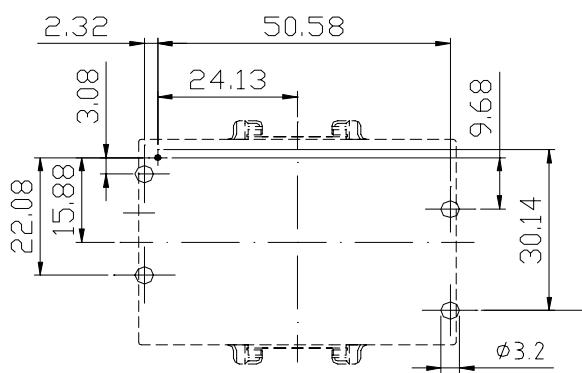
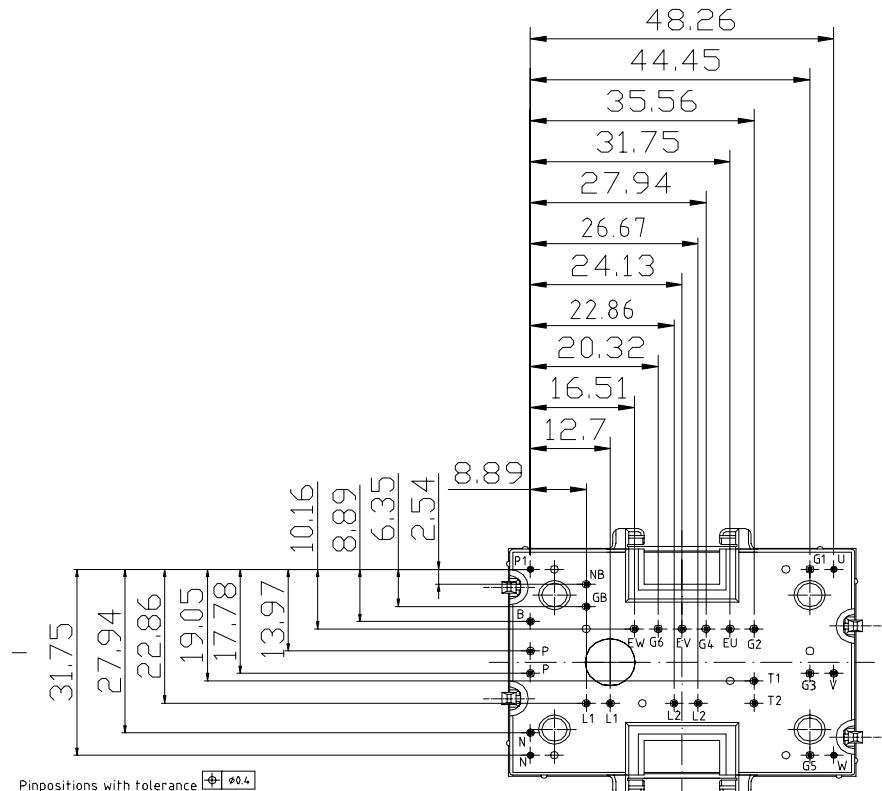
Vorläufig  
preliminary

Durchlaßkennlinie der Gleichrichterdiode (typisch)       $I_F = f(V_F)$   
 forward characteristic of rectifier diode (typical)



NTC- Temperaturkennlinie (typisch)       $R = f(T)$   
 NTC- temperature characteristic (typical)



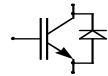

**Vorläufig  
preliminary**
**Schaltplan/ circuit diagram****Gehäuseabmessungen/ package outlines**

# Technische Information / technical information

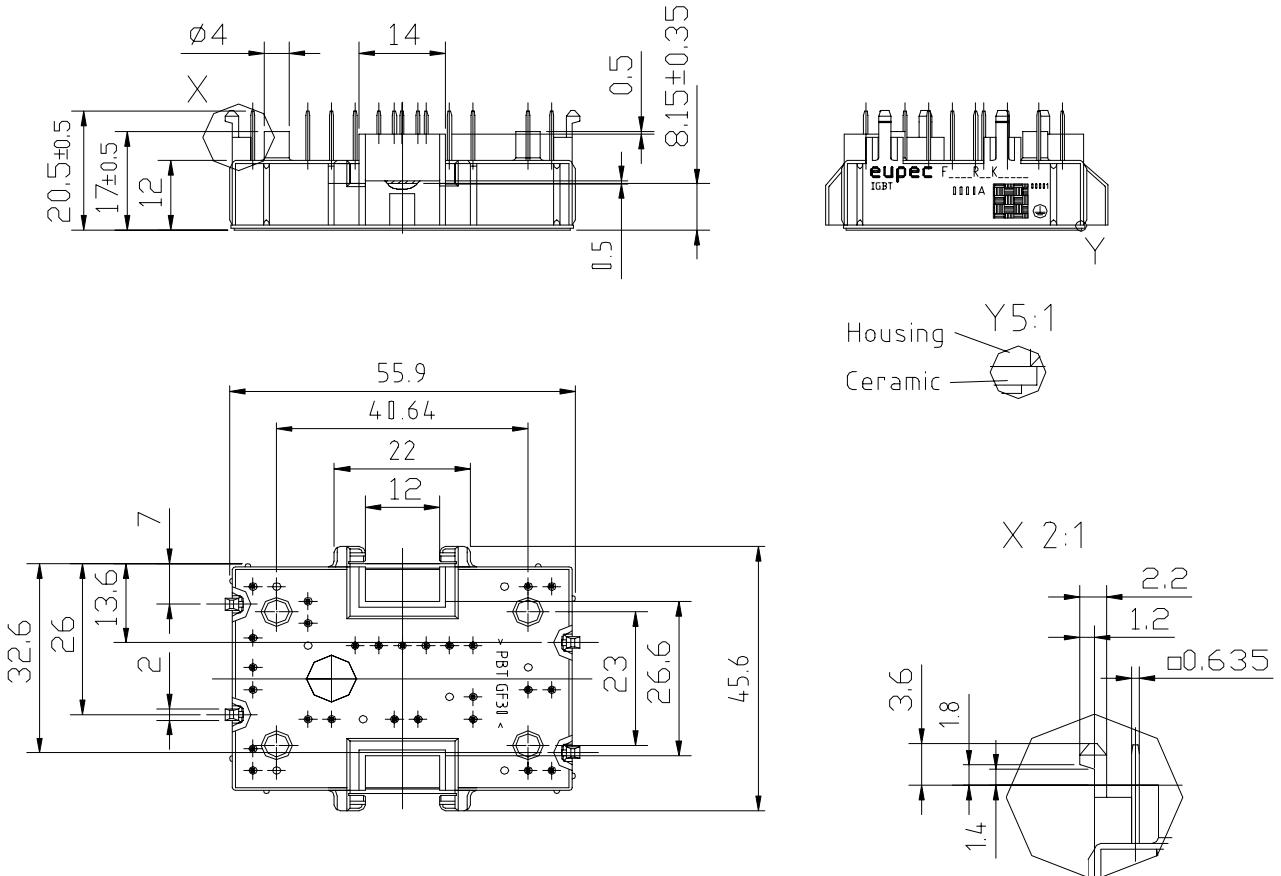
IGBT-Module  
IGBT-Modules

**eupc**

**FB15R06KL4B1**



Gehäuseabmessungen Forts. / package outlines contd.



Mit dieser technischen Information werden Halbleiterbauelemente spezifiziert, jedoch keine Eigenschaften zugesichert. Sie gilt in Verbindung mit den zugehörigen technischen Erläuterungen.

This technical information specifies semiconductor devices but promises no characteristics. It is valid in combination with the belonging technical note!

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